



**ALPHA & OMEGA**  
SEMICONDUCTOR

**AOT286L/AOB286L**

**80V N-Channel MOSFET**

### General Description

The AOT286L/AOB286L uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$ , Ciss and Coss. This device is ideal for boost converters and synchronous rectifiers for consumer, telecom, industrial power supplies and LED backlighting.

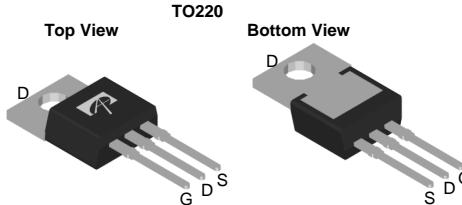
### Product Summary

$V_{DS}$	80V
$I_D$ (at $V_{GS}=10V$ )	70A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 6.0mΩ (< 5.7mΩ*)
$R_{DS(ON)}$ (at $V_{GS}=6V$ )	< 7.9mΩ (< 7.6mΩ*)

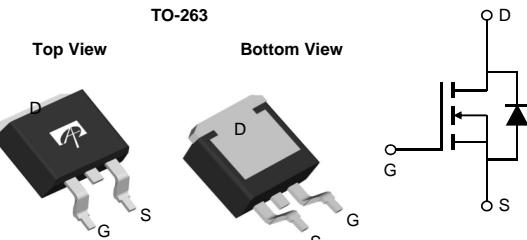
100% UIS Tested  
100%  $R_g$  Tested



**AOT286L**



**AOB286L**



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	80	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>G</sup>	$I_D$	70	A
$T_C=100^\circ\text{C}$		55	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$	245	A
Continuous Drain Current	$I_{DSM}$	13	A
$T_A=70^\circ\text{C}$		10.5	
Avalanche Current <sup>C</sup>	$I_{AS}$	50	A
Avalanche energy $L=0.1\text{mH}$ <sup>C</sup>	$E_{AS}$	125	mJ
Power Dissipation <sup>B</sup>	$P_D$	167	W
$T_C=100^\circ\text{C}$		83	
Power Dissipation <sup>A</sup>	$P_{DSM}$	2.1	W
$T_A=70^\circ\text{C}$		1.3	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	12	15	°C/W
Maximum Junction-to-Ambient <sup>A,D</sup>		48	60	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.7	0.9	°C/W

\* Surface mount package TO263

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	80			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=80\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.3	2.7	3.3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	245			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$ TO220 $T_J=125^\circ\text{C}$		5.0 8.1	6.0 9.8	$\text{m}\Omega$
		$V_{GS}=6\text{V}, I_D=20\text{A}$ TO220		6.1	7.9	$\text{m}\Omega$
		$V_{GS}=10\text{V}, I_D=20\text{A}$ TO263		4.7	5.7	$\text{m}\Omega$
		$V_{GS}=6\text{V}, I_D=20\text{A}$ TO263		5.8	7.6	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$	60			S
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.7	1	V
$I_S$	Maximum Body-Diode Continuous Current <sup>G</sup>				70	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=40\text{V}, f=1\text{MHz}$		3142		pF
$C_{\text{oss}}$	Output Capacitance			435		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			43		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	0.6	1.3	2.0	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_{\text{g}(10\text{V})}$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=40\text{V}, I_D=20\text{A}$		44.5	63	nC
$Q_{\text{gs}}$	Gate Source Charge			12		nC
$Q_{\text{gd}}$	Gate Drain Charge			8		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=40\text{V}, R_L=2\Omega, R_{\text{GEN}}=3\Omega$		13.5		ns
$t_r$	Turn-On Rise Time			11		ns
$t_{\text{D(off)}}$	Turn-Off DelayTime			32		ns
$t_f$	Turn-Off Fall Time			11		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		29		ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		161		nC

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The Power dissipation  $P_{\text{DSM}}$  is based on  $R_{\theta JA}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design, and the maximum temperature of  $175^\circ\text{C}$  may be used if the PCB allows it.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=175^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=175^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.

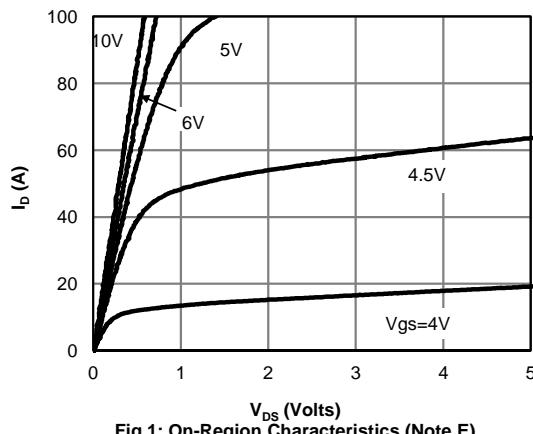
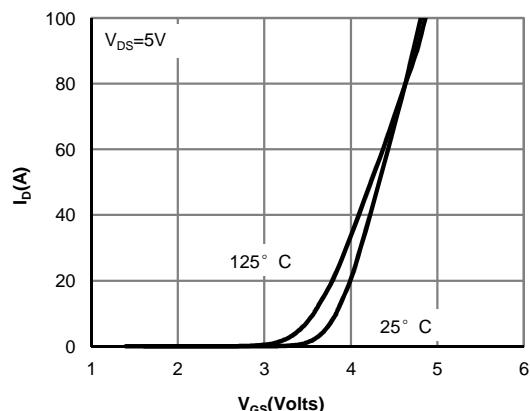
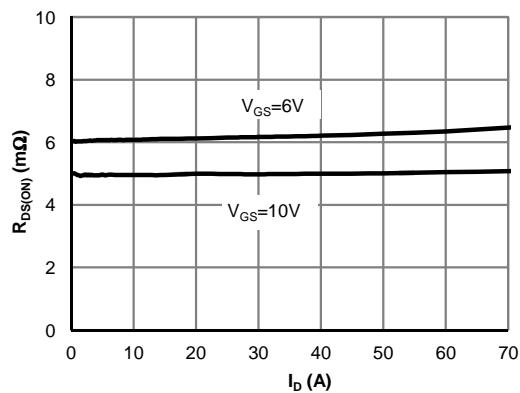
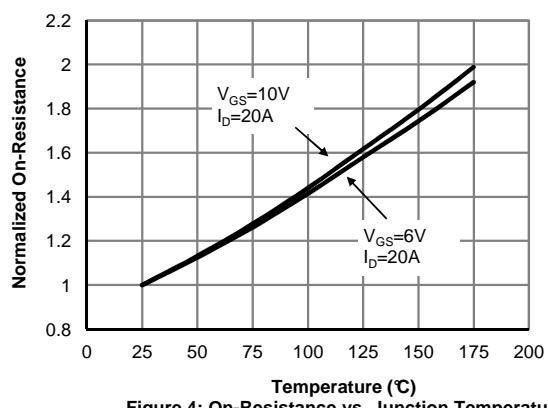
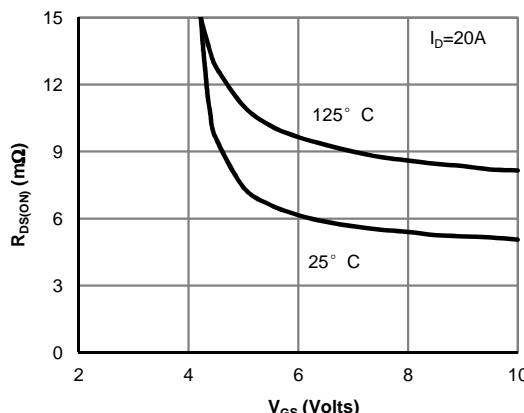
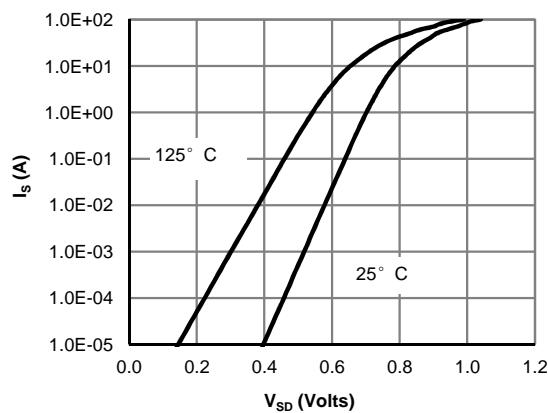
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

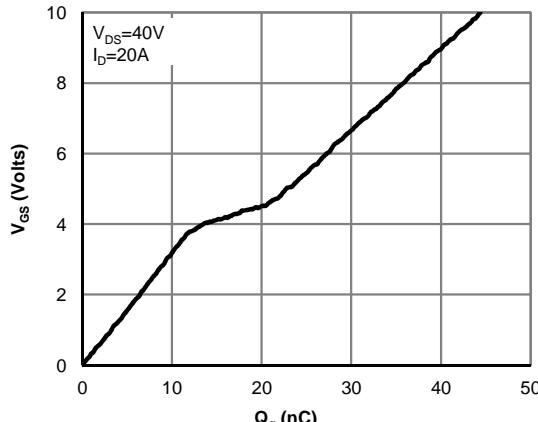
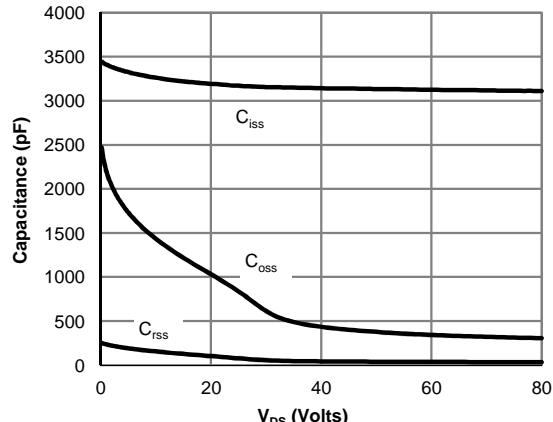
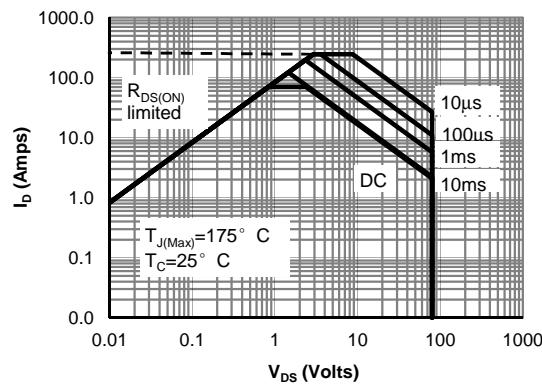
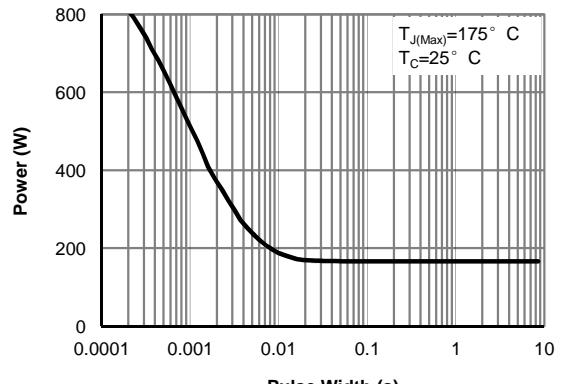
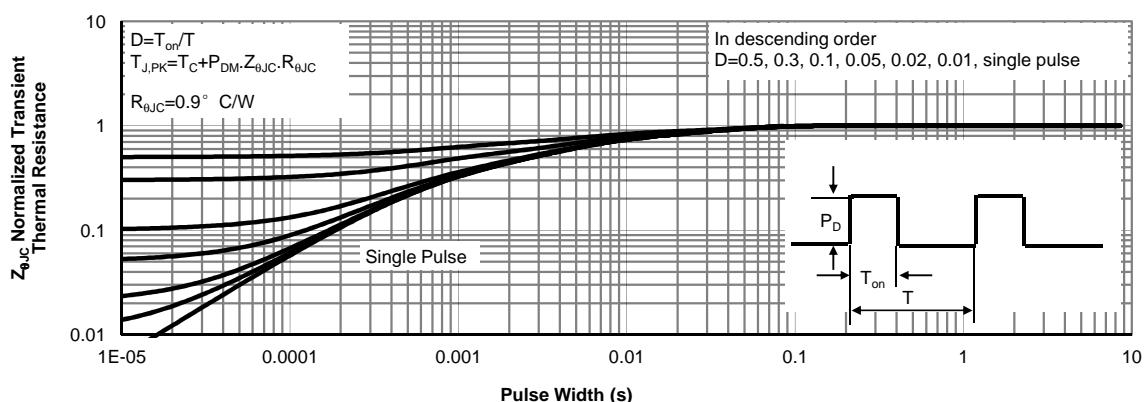
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=175^\circ\text{C}$ . The SOA curve provides a single pulse rating.

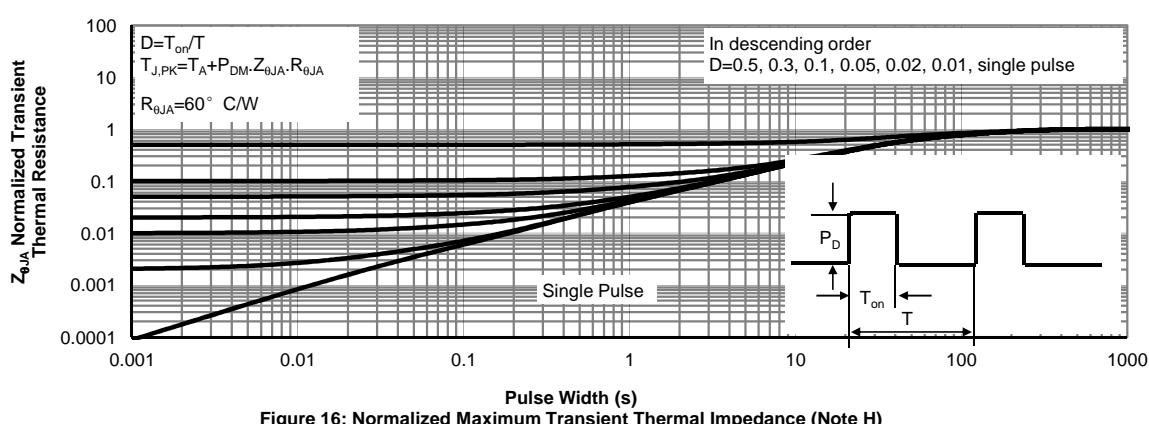
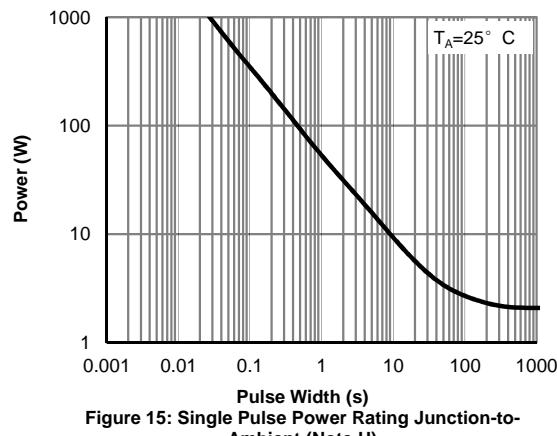
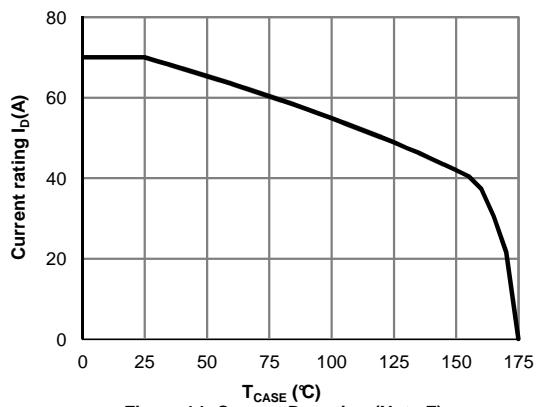
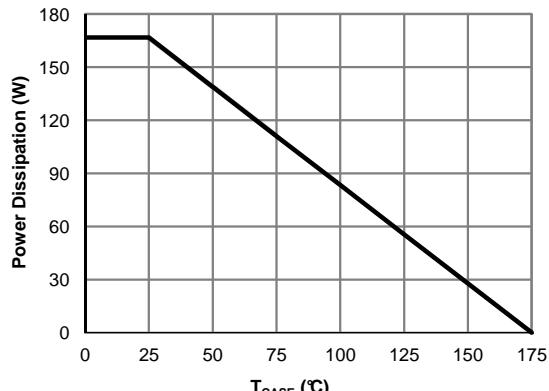
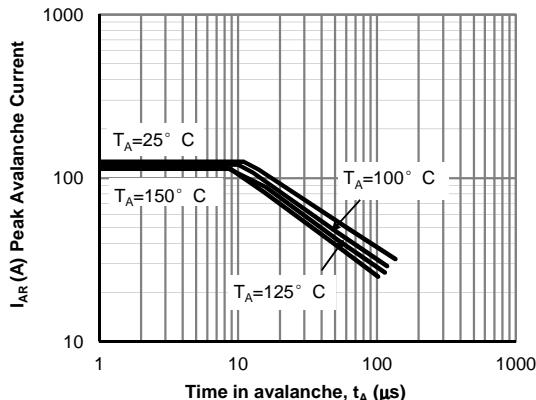
G. The maximum current limited by package.

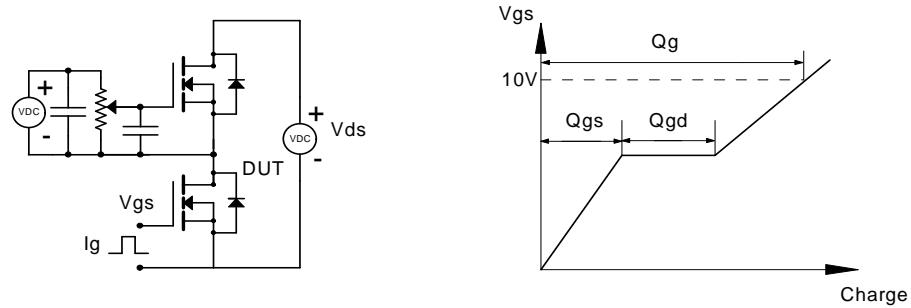
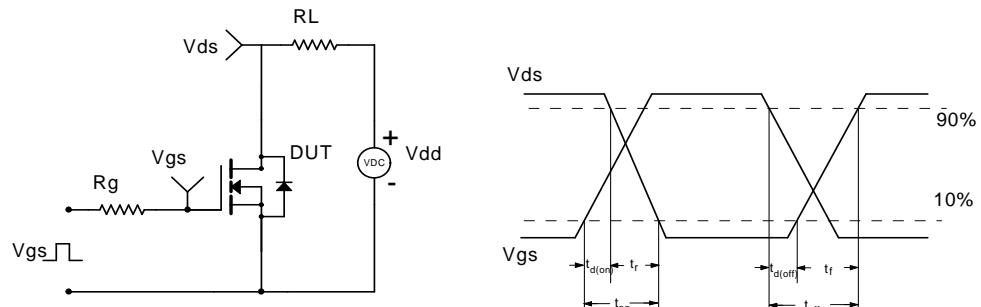
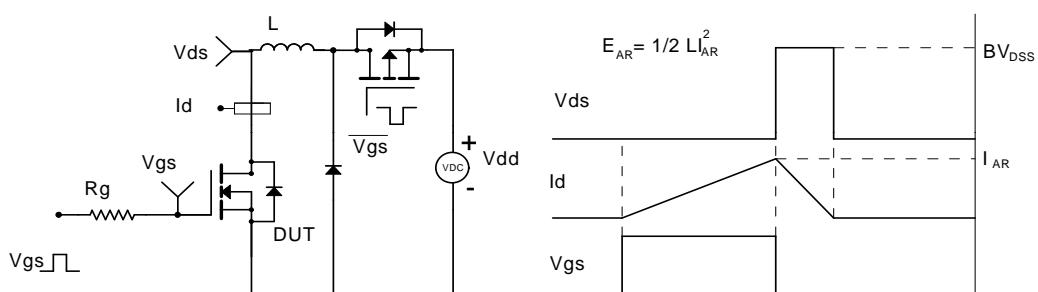
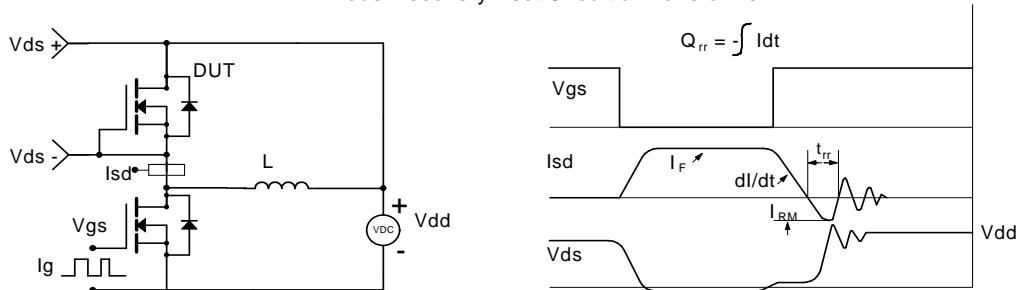
H. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Fig 1: On-Region Characteristics (Note E)**

**Figure 2: Transfer Characteristics (Note E)**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)**

**Figure 4: On-Resistance vs. Junction Temperature (Note E)**

**Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)**

**Figure 6: Body-Diode Characteristics (Note E)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 7: Gate-Charge Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Maximum Forward Biased Safe Operating Area (Note F)**

**Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)**

**Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

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